

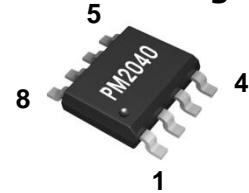
Features

- 800MHz - 2700MHz
- 33.0 dB Gain at 900MHz
- +24.5 dBm P1dB
- +41 dBm Output IP3
- Single Voltage Supply
- Lead-free / Green / RoHS-compliant SOIC-8 Package

Applications

- Mobile Infrastructure
- Cellular, GSM
- PCS, WCDMA, WiBro, WiMax
- W-LAN / ISM
- RFID / Fixed Wireless

Functional Diagram



Function	Pin No.
RF IN	3
RF OUT / Bias	6,7
Ground	2,4,5

Description

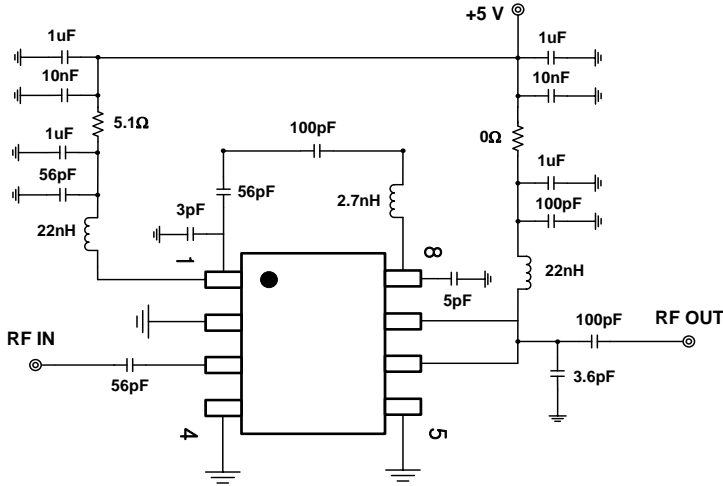
The PM2040 is a high performance InGaP HBT MMIC Amplifier and high linearity driver amplifier in a high quality SOIC-8 package. The device features excellent Input and output return loss, highly linear performance. The device can be easily matched to obtain optimum power and linearity. The product is targeted for use as driver amplifier for wireless infrastructure applications. The PM2040 operates from a single +5 voltage supply and have an internal active bias. All devices are 100% RF and DC tested

Specifications

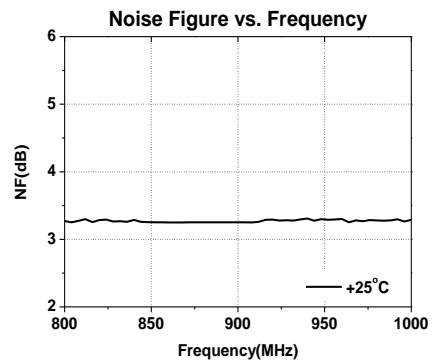
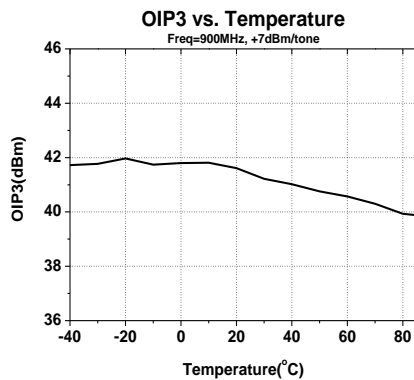
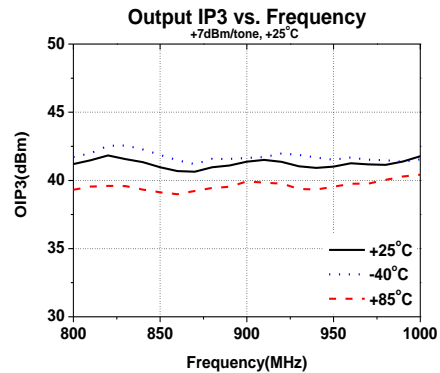
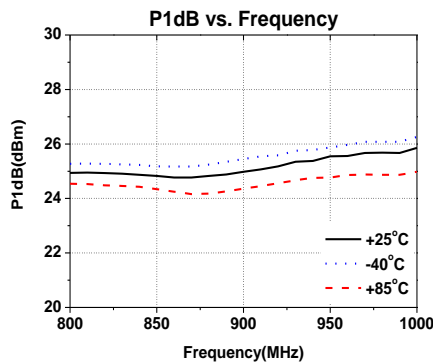
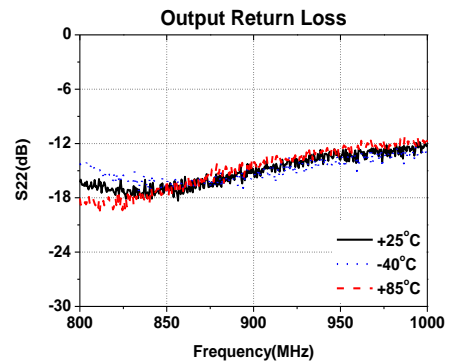
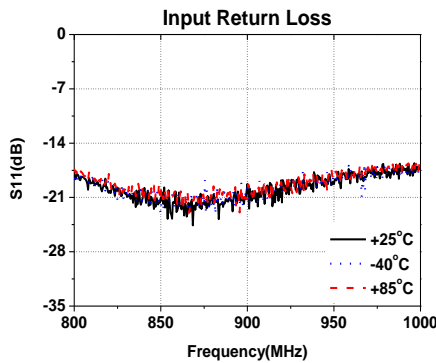
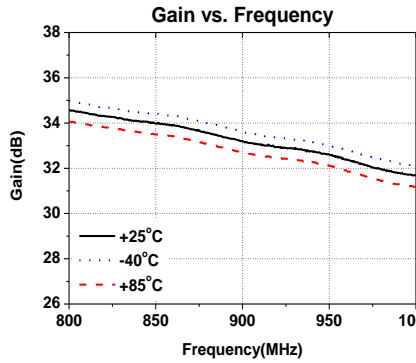
Symbol	Parameters	Units	Freq.	Min.	Typ.	Max.
S21	Gain	dB	900 MHz 1900 MHz 2140 MHz		33.0 25.3 24.0	
S11	Input Return Loss	dB	900 MHz 1900 MHz 2140 MHz		-17 -15 -20	
S22	Output Return Loss	dB	900 MHz 1900 MHz 2140 MHz		-14 -15 -15	
P1dB	Output Power @1dB compression	dBm	900 MHz 1900 MHz 2140 MHz		24.5 25.0 25.0	
OIP3	Output Third Order intercept	dBm	900 MHz 1900 MHz 2140 MHz		41.0 41.0 40.5	
NF	Noise Figure	dB	900 MHz 1900 MHz 2140 MHz		3.3 3.5 3.5	
V / I	Device voltage / current	V/mA			5/200	
Rth	Thermal Resistance	°C/W			55	

Test Conditions : T=25°C, Supply Voltage=+5.5V, 50ohm System, OIP3 measured with two tones at an output power of +7dBm/tone separated by 1MHz.

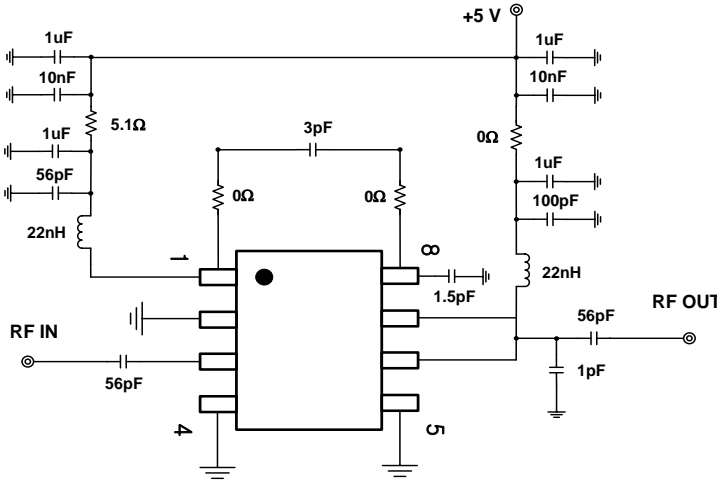
900 MHz Application Circuit



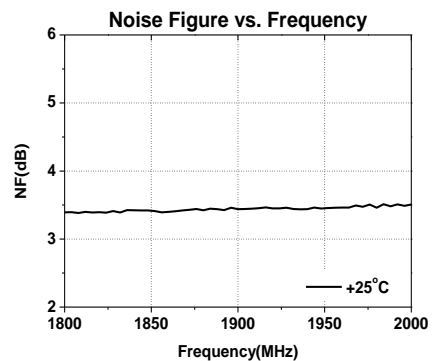
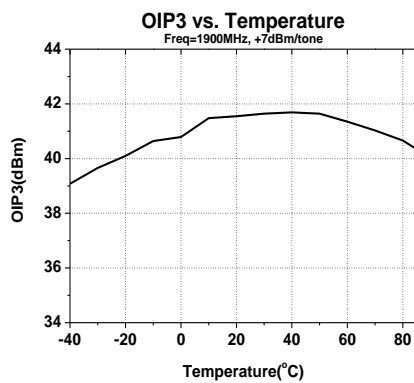
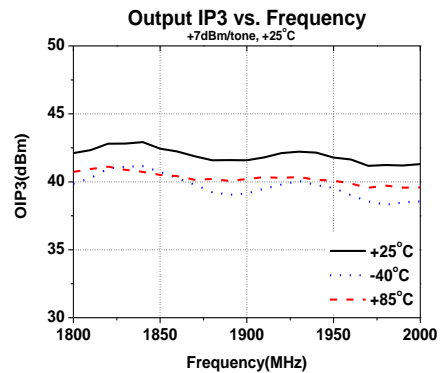
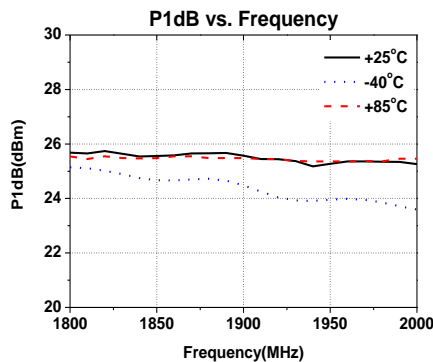
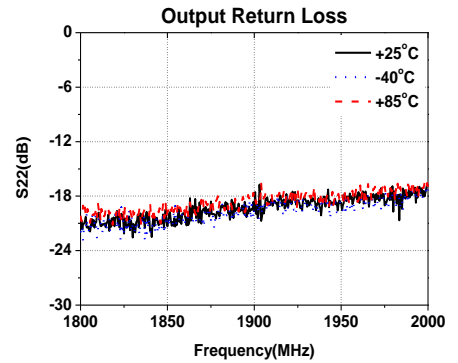
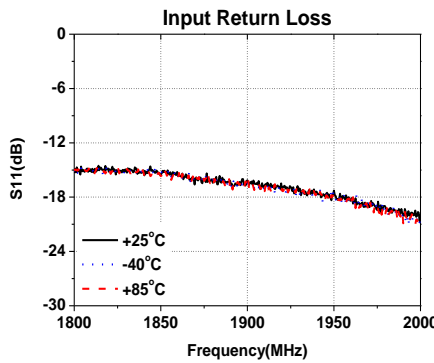
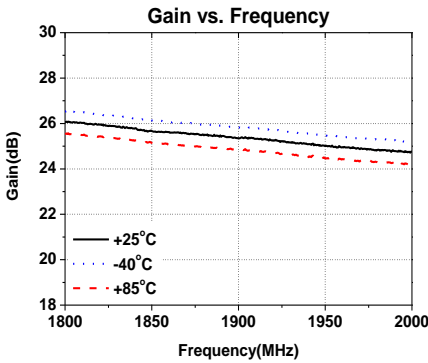
Frequency	900 MHz
S21 : Gain	33.2 dB
S11 : Input Return Loss	-18 dB
S22 : Output Return Loss	-15 dB
Output P1dB	+24.8 dBm
Output IP3 @7dBm	+41.3 dBm
Noise Figure	3.3 dB
Supply Voltage	5 V
Current	201 mA



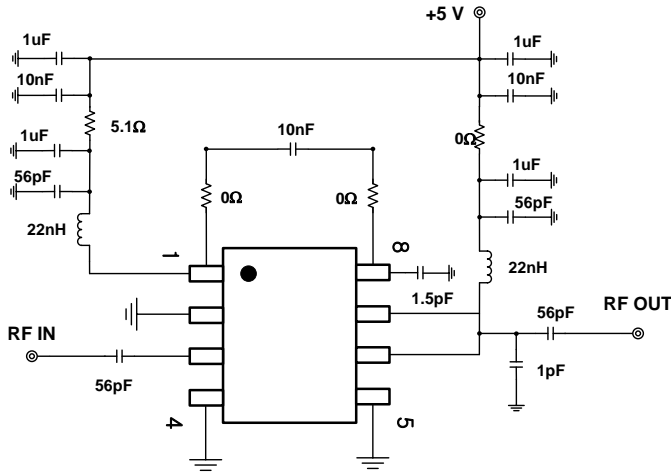
1900 MHz Application Circuit



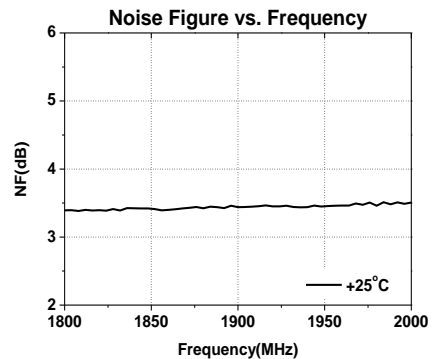
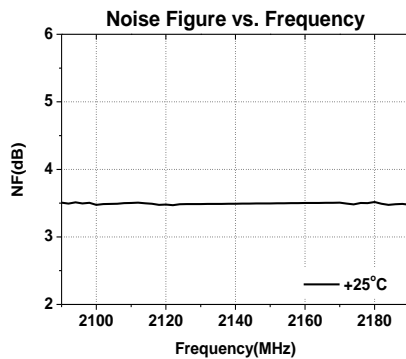
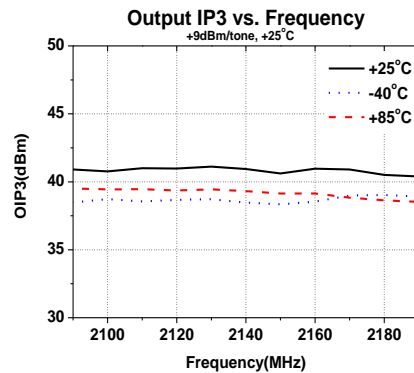
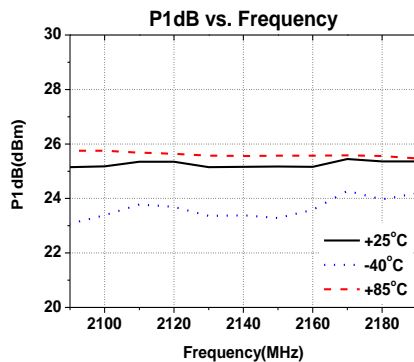
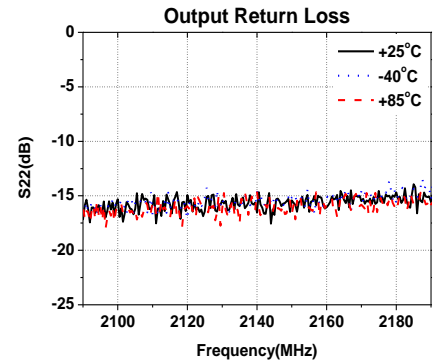
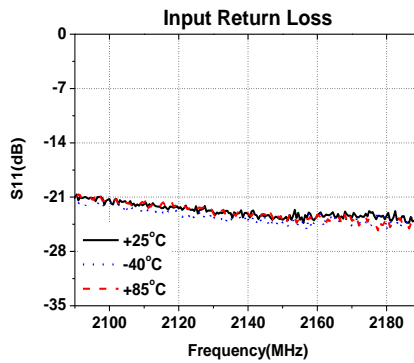
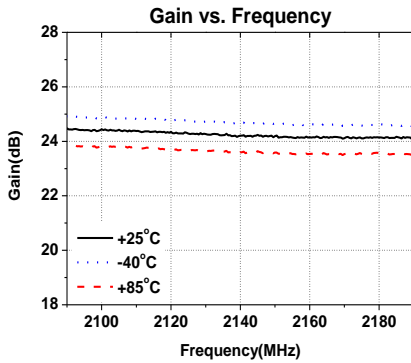
Frequency	1900 MHz
S21 : Gain	25.2 dB
S11 : Input Return Loss	-15 dB
S22 : Output Return Loss	-17 dB
Output P1dB	+25.5 dBm
Output IP3 @7dBm	+41.3 dBm
Noise Figure	3.5 dB
Supply Voltage	5 V
Current	201 mA



2140 MHz Application Circuit



Frequency	2140 MHz
S21 : Gain	24.1 dB
S11 : Input Return Loss	-22 dB
S22 : Output Return Loss	-16 dB
Output P1dB	+25.1 dBm
Output IP3 @8dBm	+40.8 dBm
Noise Figure	3.5 dB
Supply Voltage	5 V
Current	201 mA



Absolute Maximum Ratings

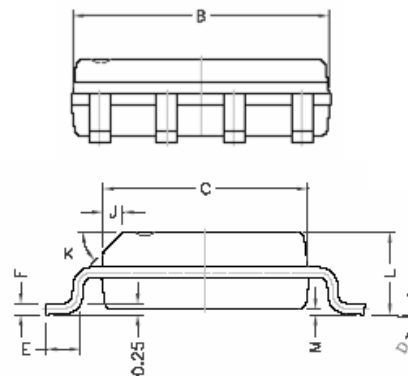
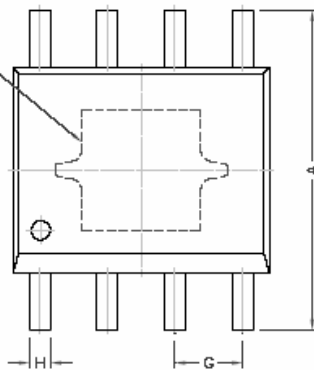
Parameter	Rating	Unit
Device Voltage	+6	V
Device Current	270	mA
RF Power Input	10	dBm
Storage Temperature	-55 to +125	°C
Ambient Operating Temperature	-40 to +85	°C
Junction Temperature	175	°C

Operation of this device above any of these parameters may cause permanent damage.



Lead-free / RoHS Compliant / Green SOIC-8 Package Outline

Thermal Pad
(See Note A)

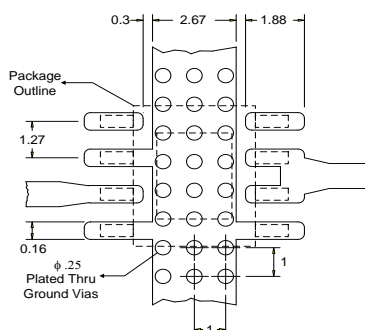


REF.	DIMENSIONS	
	Millimeters	
	Min.	Max.
A	5.80	6.20
B	4.80	5.00
C	3.80	4.00
D	0°	8°
E	0.40	0.90
F	0.19	0.25
M	0	0.15
H	0.35	0.49
L	1.35	1.75
J	0.375 REF.	
K	45°	
G	1.27 TYP.	

NOTES:

A: Thermal Pad Dimensions 25 ±0.1

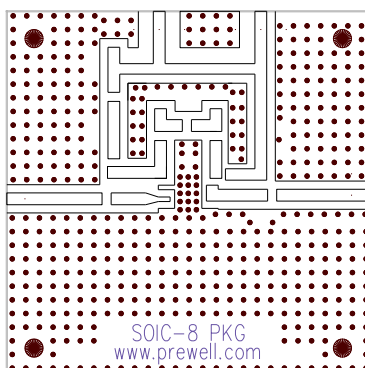
Land Pattern



ESD / MSL Ratings

- ESD sensitive device.
Observe Handling Precautions.
- ESD Rating : Class 1C (Passes at 1000V min.)
Human Body Model (HBM), JESD22-A114
- ESD Rating : Class IV (Passes at 1000V min.)
Charged Device Model (CDM), JESD22-C101
- MSL (Moisture Sensitive Level) Rating : Level 3
at +260°C Convection reflow, J-STD-020

Evaluation Board Layout (4x4)



Mounting Instructions

- Use a large ground pad area with many plated through-holes as shown.
- We recommend 1 oz copper minimum.
- Measurement for our data sheet was made on 0.8mm thick FR-4 Board.
- Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- RF trace width depends on the board material and construction.
- Add mounting screws near the part to fasten the board to a heatsink.